

CHCRUS

This is the accepted manuscript made available via CHORUS. The article has been published as:

Phase-field model of insulator-to-metal transition in VO_{2} under an electric field

Yin Shi and Long-Qing Chen Phys. Rev. Materials **2**, 053803 — Published 23 May 2018 DOI: 10.1103/PhysRevMaterials.2.053803

Phase-field model of insulator-to-metal transition in VO₂ under an electric field

Yin Shi^{*} and Long-Qing Chen[†]

Department of Materials Sciences and Engineering, Pennsylvania State University, University Park, PA 16802, USA

(Dated: May 9, 2018)

The roles of an electric field and electronic doping in insulator-to-metal transitions are still not well understood. Here we formulated a phase-field model of insulator-to-metal transitions by taking into account both structural and electronic instabilities as well as free electrons and holes in VO₂, a strongly correlated transition metal oxide. Our phase-field simulations demonstrate that in a VO₂ slab under a uniform electric field, an abrupt universal resistive transition occurs inside the supercooling region in sharp contrast to the conventional Landau-Zener smooth electric breakdown. We also show that hole doping may decouple the structural and electronic phase transitions in VO₂, leading to a metastable metallic monoclinic phase which could be stabilized through a geometrical confinement and the size effect. This work provides a general mesoscale thermodynamic framework for understanding the influences of electric field, electronic doping, and stress/strain on insulator-tometal transitions and the corresponding mesoscale domain structure evolution in VO₂ and related strongly correlated systems.

I. INTRODUCTION

Vanadium dioxide (VO_2) , a strongly correlated transition metal oxide, undergoes a first-order insulator-tometal transition (IMT) from a monoclinic insulator (M1) to a rutile metal (R) at $T_c = 338$ K upon heating¹. The coexistence of the strong electron correlation and the V dimerization obscures the nature of the resistive transition in VO_2 . While the strong dimerization suggests a Peierls transition, recent microscopic theories uncovered the crucial role of the electron correlation $^{2-4}$. Moreover, recent experiments demonstrated that the structural and electronic phase transitions in VO_2 may be decoupled, e.g., through a contact of a VO₂ nanobeam with a metallic substrate⁵, an elastic constraint on a VO_2 thin film⁶, or a combination of hole doping and geometrical confinement for a VO_2 thin film⁷. Therefore, it is imperative that both structural and electronic instabilities are incorporated in any thermodynamic theory of the IMT in VO_2 .

A sufficient amount of free charges may alter the IMT by screening the electron-electron repulsion and thus reducing the electron correlation⁸. It was experimentally demonstrated that an applied electric field is able to drive the IMT via a field-induced charge accumulation. In a VO_2 transistor, the bulk conductive channels open up collectively above a threshold voltage, with an extension far exceeding the Thomas-Fermi screening length⁹. This is in sharp contrast to the standard field-induced Landau-Zener breakdown activated smoothly at a field of the order of the energy gap, which is predicted by the across-gap tunneling $^{10,11}.\,\,$ There are also experimental evidences that demonstrate the ability of electronic doping, i.e., introduction of holes or electrons through solute dopants and defects, to modulate the IMT in VO_2 , e.g., in doped $M_x V_{1-x} O_2$ (M = Ti⁴⁺, W⁶⁺, Mo⁶⁺ or $Nb^{5+})^{12}$ and $VO_2 - VO_{2-\delta}$ bilayers⁷. The measurement of the phase transitions in the $VO_2-VO_{2-\delta}$ bilayer further unveiled the presence of a metallic monoclinic (MM)

phase in the hole-doped and geometrically confined VO_2 layer⁷. Such a MM phase is, however, absent in the pristine bulk VO_2 .

Although the microscopic quantum theories may provide physical insights into the IMT at the electronic structure level^{2–4}, the mesoscale mechanisms and domain evolution during the IMT of a doped crystal under an electric field and/or stress require mesoscale continuum models that take into account the electron correlation, structural changes, as well as the presence of free charges. In this article, we formulate a phase-field model with the thermodynamics described by a Landau potential as a function of structural order parameters, spin-correlation order parameters¹³, and free electron and hole concentrations. As an example, we study the electric breakdown of a VO_2 slab under a uniform electric field. It is shown that inside the supercooling region, it occurs through an abrupt universal IMT in sharp contrast to the smooth Landau-Zener breakdown. We then study the IMT in a VO₂-VO_{2- δ} bilayer, and show that hole doping in the VO_2 layer may induce a metastable MM phase which could be stabilized via a geometrical confinement between the two layers and the size effect.

II. THERMODYNAMICS OF A LATTICE/ELECTRON SYSTEM

By examining the symmetry breaking of the magnetic group during the IMT, we previously formulated a bulk Landau potential incorporating a set of structural order parameters η_i , i = 1, 2, 3, 4 and a set of spincorrelation order parameters μ_i , i = 1, 2, 3, 4 (characterizing the magnetic order) to explicitly describe the structural and electronic transitions during the IMT in the *pristine* VO₂¹³. It reads (per unit cell)¹³

$$F(\eta,\mu) = \frac{a}{2} \frac{T - T_0}{T_c} \eta_i \eta_i + \frac{b_{ij}}{4} \eta_i^2 \eta_j^2 + \frac{c_{ij}}{6} \eta_i^2 \eta_j^4$$

$$+ \frac{A}{2} \frac{T - T'_0}{T_c} \mu_i \mu_i + \frac{B_{ij}}{4} \mu_i^2 \mu_j^2 + \frac{C_{ij}}{6} \mu_i^2 \mu_j^6 + g\eta_i \mu_i - \frac{g_{ijkl}}{2} \eta_i \eta_j \mu_k \mu_l + \frac{q_{ijkl}}{2} \eta_i \eta_j \eta_k \mu_l, \quad (1)$$

where T is the temperature and other parameters are constants (satisfying certain symmetry relations¹³), and the Einstein summation convention is used. A finite η_i indicates the dimerization of the neighboring V atoms, and a finite μ_i indicates the formation of the dynamical singlet situated on the neighboring V sites 13 , which may be directly related to the opening of the energy gap^{2-4} . Hereafter we simplify the description of the theory by reducing the four-dimensional order parameters η_i and μ_i to one-dimensional order parameters $\eta \equiv \sqrt{\sum_i \eta_i^2}$ and $\mu \equiv -\sqrt{\sum_i \mu_i^2}$. The order parameter values for R, M1 and MM phases are $(\eta = 0, \mu = 0), (\eta \neq 0, \mu \neq 0)$ and $(\eta \neq 0, \mu = 0)$, respectively¹³. In the presence of free electrons and holes, the total bulk Landau potential can be written as a sum of the contribution from the pristine VO_2 and that from the free charges

+g

$$\Omega_t(\eta, \mu, n, p) = F(\eta, \mu) + \Omega(\mu, n, p), \tag{2}$$

where n and p are the concentrations of the free electrons and holes, respectively. Ω is the (non-equilibrium) thermodynamic potential of the free charges. It must depend on the electronic order parameter μ . The equilibrium state can be determined by minimizing Ω_t with respect to all the order parameters η, μ, n and p^{14} .

 Ω may be approximated using the effective two-band model for semiconductors, in which the energy bands are approximated as only one band below (valence band, at energy E_v with an effective density of states N_v) and one band above (conduction band, at energy E_c with an effective density of states N_c) the Fermi level E_{F0}^{15} . The equilibrium electron and hole concentrations at zero field can be approximated by the Boltzmann distribution, $n = N_c \exp[-(E_c - E_{F0})/k_B T]$ and $p = N_v \exp[-(E_{F0} - E_v)/k_B T]^{15}$, where k_B is the Boltzmann constant. Substituting $E_{F0} = E_F + (E_c + E_v)/2$ into these expressions where E_F is the Fermi level measured from the midpoint of the energy gap, one can see that equivalently $n = N_c \exp[-(E_g/2 - E_F)/k_BT]$ and $p = N_v \exp[-(E_g/2 + E_F)/k_BT]$, where $E_g = E_c - E_v$ is the gap. Hence, referencing to the midpoint of the gap, the energies of the electrons and holes are both $E_q/2$, while their chemical potentials are E_F and $-E_F$, respectively. Ω may then read (per unit cell)

$$\Omega = \frac{E_g}{2}(n+p) + eV(p-n) - TS - E_F(n-p+N_a-N_d) - \Omega_0.$$
(3)

Here V is the electric potential, e is the elementary charge, $S = -k_B n [\ln(n/N_c) - 1] - k_B p [\ln(p/N_v) - 1]$ is the entropy, and N_a and N_d are the acceptor and donor concentrations, respectively. $\Omega_0 = -2k_BTn_i$ is a reference energy with $n_i = \sqrt{N_c N_v} \exp(-E_g/2k_B T)$ being the intrinsic carrier concentration. Note that in the E_F term in Eq. (3), $(N_d - N_a)$ is subtracted from (n - p), i.e., $(N_d - N_a)$ free charges, which are released from dopants, do not participate in the (non-equilibrium) process of particle number variation (recombination). This is because these dopants are assumed a priori to remain ionized. E_q can be approximated as¹³

$$E_g \approx \frac{2U^2 \mu_0^2 \mu^2}{k_B T_c},\tag{4}$$

where U is the onsite Coulomb repulsion and μ_0 a dimensionless parameter. Fitting this to the measured value of the energy gap ~ 0.67 eV of the M1 phase¹⁶ with $U \sim 4 \text{ eV}^2$, we obtain $\mu_0 = -0.025$. The minimization of Ω_t with respect to n and reconciling $_{\mathrm{the}}$ Debye-Hückel approximation¹⁷. With the charge neutrality condition at zero field $n + N_a = p + N_d$, one also finds $E_F =$ $k_B T \ln \left[\sqrt{\frac{N_v}{N_c}} \frac{(N_d - N_a)/2 + \sqrt{(N_d - N_a)^2/4 + n_i^2}}{n_i} \right]$

We note that mathematically E_F in Eq. (3) is a Lagrange multiplier for maintaining charge neutrality.

The Ω added to F in Eq. (2) may alter the IMT of the pristine VO_2 . To see this, one can substitute n and p with their equilibrium values and leave Ω_t as a function of μ and η only, which allows for a convenient comparison between the total Landau potentials before and after the inclusion of Ω . In the zero field and intrinsic (no doping) case, one obtains $\Omega = 0$ and $\Omega_t(\eta,\mu) = F(\eta,\mu)$ at equilibrium, which recovers the Landau potential of the pristine VO_2 . In the intrinsic case but with an applied electric field, one has $\Omega_t(\eta,\mu) = F(\eta,\mu) - 2k_B T n_i [\cosh(eV/k_B T) - 1]$ at equilibrium, which, by expansion to the first order of E_q (considering temperatures near T_c), gives

$$\Omega_t(\eta,\mu) \approx F(\eta,\mu) + [\cosh(eV/k_BT_c) - 1]\sqrt{N_cN_v}E_g,$$
(5)

in which the constant terms independent of η and μ have been dropped. Using Eq. (4) one finds that the E_q term added to F will renormalize the Curie-Weiss temperature of the spin-correlation order parameter, i.e., T'_0 in Eq. (1), by always lowering it by an amount $4[\cosh(eV/k_BT_c) - 1]\sqrt{N_cN_v}U^2\mu_0^2/k_BA$. This indicates that the applied electric potential assists the transition from an insulator to a metal. In the doped case but at zero field, imagining hole doping $N_a \gg n_i$ and $N_d = 0$, one obtains at equilibrium $p \approx N_a \gg n \approx n_i^2/N_a$ and

$$\Omega_t(\eta,\mu) \approx F(\eta,\mu) + \frac{N_a E_g}{2},\tag{6}$$

in which the constant terms independent of η and μ have also been dropped. Similar to the case with the applied electric field, the E_g term added to F will renormalize T'_0 by always lowering it by an amount $2U^2\mu_0^2N_a/k_BA$, indicating that hole doping assists the transition from an insulator to a metal.



FIG. 1. (a) Spatial profiles of the spin-correlation order parameter at an applied voltage 0.4 V, outside (T = 300 K) and inside (T = 337 K) the supercooling region, respectively. The inset is a schematic of the geometry. (b) The length of the metallic region as a function of the applied electric field at the two temperatures. The lines are guide to eyes. The inset shows the theory fit of the nonzero $l_{\rm M}$ at T = 300 K.

III. RESISTIVE SWITCHING IN VO₂ UNDER AN ELECTRIC FIELD

We employ Eq. (5) to simulate the IMT in VO₂ under an electric field. As shown in the inset of Fig. 1(a), we consider a VO₂ slab of a length L = 250 nm (along the xdirection) subject to a uniform electric field $E = \Delta V/L$ (Coulomb gauge, where ΔV is the voltage drop across the slab) in the x direction, assuming an open circuit configuration. The electric potential is V(x) = E(x - L/2) as we set the x = 0 point at the left surface of the slab. Using the phase-field method¹⁸, we calculate the stable states of the slab subject to an applied voltage $\Delta V = 0.4$ V, at T = 300 K and T = 337 K, which are outside and inside the supercooling region, respectively (the Landau potential yields a supercooling temperature $T_s = 309$ K). The results are shown in Fig. 1(a).

At 300 K, the two oppositely charged surfaces of the slab turn into metal that gradually grows as the electric field E increases [see Fig. 1(b)], while the middle part of the slab remains insulating, forming an insulating tunnel between the two metallic regions. The metal-



FIG. 2. Total Landau potentials of the metal-insulatormetal sandwich (blue squares) and the metal (red diamonds) as a function of the electric field at 337 K. The lines are guide to eyes. Filled and empty markers indicate stable and metastable states, respectively. The threshold E and $l_{\rm M}$ of the sandwich at the crossing point of the Landau potentials are 4.5×10^5 V/m and 126 nm, respectively, as indicated in the figure.

lic regions will finally touch each other at a threshold electric field $E_{\rm th}$, which essentially corresponds to the Landau-Zener tunnel breakdown^{10,11}. To calculate $E_{\rm th}$, we employ a theory fit to extrapolate the simulation data in Fig. 1(b), as numerical errors occur in simulations at large V due to the exponential dependence of Ω in Eq. (5) on V. Since the applied voltage creates two metal-insulator domain walls, we consider the effective domain wall repulsion induced by finite domain wall width, $F_{\rm rep} = v \exp[-(L - l_{\rm M})/w]^{19}$, with the parameters v and w to be fitted ($l_{\rm M}$ is the total length of the metallic regions). The equilibrium $l_{\rm M}$ corresponds to the minimum of the total Landau potential (including $F_{\rm rep}$) with respect to $l_{\rm M}$, which is achieved by

$$\frac{\Omega_t(x = l_{\rm M}/2)|_{\rm R} - \Omega_t(x = l_{\rm M}/2)|_{\rm M1}}{\mathcal{V}} + \frac{dF_{\rm rep}}{dl_{\rm M}} = 0, \quad (7)$$

where \mathcal{V} is the unit cell volume of VO₂. The inset of Fig. 1(b) presents the comparison of $l_{\rm M}$ obtained from Eq. (7) and that from the simulation data, showing a good fitting yielding $v = 273 \text{ mJ/m}^2$ and w = 109 nm. Extrapolation from the theory fit gives $E_{\rm th} = 2.87 \times 10^7 \text{ V/m}$ at 300 K, which is comparable with the $E_{\rm th}$ measured by the experiment $\leq 10^8 \text{ V/m}^{20}$ and that estimated from the Zener tunnel breakdown $\sim 4 \times 10^7 \text{ V/m}^{11}$ for VO₂.

At 337 K, the whole slab turns into metal with a uniformly distributed zero order parameter at $\Delta V = 0.4$ V. As can be seen in Fig. 1(b), the metallic regions initiated from the two surfaces first grow gradually to 126 nm as E increases, and then abruptly spreads throughout the whole slab, which is in sharp contrast with the 300 K case. This novel behavior essentially rises from the presence of the metastable metallic phase inside the



FIG. 3. Temperature-electric field phase diagram of VO₂. The threshold voltage $\Delta V_{\rm th} = E_{\rm th}L$ corresponding to each value of the threshold electric field is also shown on the right y axis.

supercooling region. We plot in Fig. 2 the total Landau potentials $\overline{\Omega}_t = \int (\Omega_t + \mathcal{V}F_{\rm gr}) dx/L$ versus E of the metal-insulator-metal sandwich formed during growth of the metallic regions and the metastable metal. Here $F_{\rm gr} = [\kappa_1 (\nabla \eta)^2 + \kappa_2 (\nabla \mu)^2]/2$ is the gradient energy density arising from the spatial variance of the order parameters¹⁸, where κ_1 and κ_2 are positive constants. As can be seen in Fig. 2, at small E the total Landau potential of the metal-insulator-metal sandwich is lower than that of the metastable metal, which corresponds to the regime of the gradual growth of the metallic region. When E exceeds a small threshold value $E_{\rm th} = 4.5 \times 10^5$ V/m, the total Landau potential of the sandwich is higher than that of the metastable metal, which stabilizes the metallic phase throughout the slab.

The reason why the total Landau potential of the sandwich could be higher than that of the metastable metal lies in the energy loss from the two metal-insulator domain walls in the sandwich, i.e., the metal-insulator domain wall energy $F_{\rm DW} = 2 \int F_{\rm gr} dx \sim 25 \text{ mJ/m}^{221}$. Although the bulk Landau potential of the sandwich $\left(\int_0^{l_{\rm M}/2} \Omega_t |_{\rm R} dx + \int_{l_{\rm M}/2}^{L-l_{\rm M}/2} \Omega_t |_{\rm M1} dx + \int_{L-l_{\rm M}/2}^{L} \Omega_t |_{\rm R} dx\right)/L$ is always lower than that of the metastable metal $\int_0^L \Omega_t |_{\rm R} dx/L$, the total Landau potential of the sandwich (including $F_{\rm DW}$ and $F_{\rm rep}$) and that of the metastable metal may cross for

$$2F_{\rm DW} + F_{\rm rep} + \left(\int_0^{l_{\rm M}/2} dx \,\frac{\Omega_t|_{\rm R}}{\mathcal{V}} + \int_{l_{\rm M}/2}^{L-l_{\rm M}/2} dx \,\frac{\Omega_t|_{\rm M1}}{\mathcal{V}} + \int_{L-l_{\rm M}/2}^{L} dx \,\frac{\Omega_t|_{\rm R}}{\mathcal{V}}\right) = \int_0^L dx \,\frac{\Omega_t|_{\rm R}}{\mathcal{V}}$$

or equivalently

$$\int_{l_{\rm M}/2}^{L-l_{\rm M}/2} dx \, \frac{\Omega_t |_{\rm R} - \Omega_t |_{\rm M1}}{\mathcal{V}} = 2F_{\rm DW} + F_{\rm rep}, \qquad (8)$$

signaling the genuine resistive transition during which the stable state of the slab sharply changes from the sandwich to the metal²². $E_{\rm th}$ can be calculated directly from Eq. (8) together with Eq. (7).

Fig. 3 presents the threshold electric field as a function of the temperature, showing two distinct regimes separated by T_s . $E_{\rm th}$ drops dramatically at T_s as T increases, characterizing the similar behavior found experimentally in the VO₂ transistor⁹. For $T < T_s$, the metallic regions initiated from the two surfaces gradually grow and finally touch each other as the electric field increases, which corresponds to the smooth insulating tunnel breakdown. For $T > T_s$, the whole slab sharply turns into metal at much smaller electric fields than those in the former case due to the competition between the metal-insulator-metal sandwich and the metastable metal, which corresponds to the genuine resistive transition²².

IV. MM PHASE IN THE VO_2 - $VO_{2-\delta}$ BILAYER

As aforementioned, a MM phase was found stabilized in the VO₂-VO_{2- δ} bilayer⁷. When the VO₂ layer and the VO_{2- δ} layer are separated by an insulating TiO₂ layer, i.e., they are electronically disconnected from each other, the two layers both undergo the normal IMT as in the pristine bulk, at critical temperatures $T_{c1} \sim 290$ K and $T_{c2} \sim 280$ K, respectively⁷. However, when the VO_{2- δ} layer is epitaxially grown on the VO₂ layer, i.e., they are electronically connected with each other, the phase transition in the bilayer becomes more complicated than in the disconnected case. It was found that, while the VO_{2- δ} layer stays in the R phase between T_{c1} and T_{c2} as in the disconnected case, the MM phase is stabilized in the VO₂ layer inside this temperature interval⁷.

To understand the phenomenon, we first establish a Landau potential in the same form of Eq. (1) that describes the phase transition in pristine VO₂ thin films. It is simplified such that the Landau parameters have already been renormalized by the (fixed) elastic energy (see details in Ref.⁷). The stoichiometry of the VO_{2- δ} layer is accounted for by the simultaneous -10 K shifting of T_0 and T'_0 with respect to the VO₂ layer case, which simply corresponds to $T_{c2} - T_{c1} \sim -10$ K. This is simple yet sufficient to describe the phase transition in the



FIG. 4. (a) Stable (solid lines) and metastable (empty lines) phases of the independent hole-doped ($N_a = 5 \times 10^{-3}$ per unit cell) VO₂ thin film at various temperatures. (b) Total Landau potential landscape of the same hole-doped VO₂ thin film at 283 K, showing the stable M1 phase accompanied with the metastable MM phase.

bilayer, since in the temperature range of interest $(T_{c1}-T_{c2})$, the VO_{2- δ} layer remains in the R phase, and we are mainly concerned with the stable phase in the VO₂ layer. In the VO₂-VO_{2- δ} bilayer, the first principles calculation shows that the VO₂ layer is hole doped through its touching with the VO_{2- δ} layer⁷. By minimizing Eq. (6) with a typical $N_a = 5 \times 10^{-3}$ per unit cell (causing a T'_0 shift ~ -10 K), we calculate the stable and metastable phases of the *independent* hole-doped VO₂ thin film at various temperatures, and the results are presented in Fig. 4(a). As can be seen, the metastable MM phase appears in the temperature interval 279–292 K, which is totally absent in the pristine case. Fig. 4(b) presents the Landau potential landscape of the same hole-doped VO₂ thin film at T = 283 K, showing the stable M1 phase accompanied with the metastable MM phase.

The appearance of the hole-doping induced metastable MM phase in the VO_2 layer may lead to nontrivial phase transitions in the VO₂-VO_{2- δ} bilayer. We propose that the metastable MM phase in the VO_2 layer could further be stabilized via the interfacial interaction with the $VO_{2-\delta}$ layer and the size effect. In the temperature interval T_{c1} - T_{c2} , the VO_{2- δ} layer stays in the R phase, and a M1-R interface or a MM-R interface will form between the VO₂ and VO_{2- δ} layers depending on whether the VO_2 layer is in the M1 phase or the MM phase. The interfacial energy $2 \int F_{\rm gr} dz$ of the MM-R interface will be smaller than that of the M1-R interface, since the κ_2 term in $F_{\rm gr}$ almost vanishes for the MM-R interface [with $(\eta \sim 1, \mu \sim 0)$ - $(\eta = 0, \mu = 0)$] while the κ_1 and κ_2 term are both finite for the M1-R interface [with $(\eta \sim 1, \mu \sim -1) - (\eta = 0, \mu = 0)]$. This may allow for



FIG. 5. Total Landau potentials (per unit cell) of the VO₂-VO_{2- δ} bilayer as a function of the VO₂ layer thickness at 283 K for the M1-R (blue circles) and MM-R (green squares) configurations. The lines are guide to eyes. The insets are the stable profiles of the order parameters for a $t < t_c$ and a $t > t_c$. The bilayer is stacked along the z direction. The arrows are the two-dimensional order parameter vector (η, μ) , and the color represents its norm $\sqrt{\eta^2 + \mu^2}$.

a lower total Landau potential of the MM-R configuration than that of the M1-R configuration for the bilayer at small VO₂ layer thicknesses, at which the interfacial energy will dominate the total Landau potential. The critical thickness below which the MM-R configuration is stable can be expressed as

$$t_c = \frac{2\int dz \left(F_{\rm gr}|_{\rm M1-R} - F_{\rm gr}|_{\rm MM-R}\right)}{\Omega_t|_{\rm MM} - \Omega_t|_{\rm M1}},$$

where z is the coordinate along the direction of the layer thickness.

To demonstrate this, we set up a VO₂-VO_{2- δ} bilayer geometry and employ the phase-field method¹⁸ to calculate the total Landau potentials $\bar{\Omega}_t = \int (\Omega_t + \mathcal{V}F_{\rm gr})dz/(t+t_0)$ of the MM-R and M1-R configurations as a function of the VO₂ layer thickness t at 283 K (t_0 is the VO_{2- δ} layer thickness). The results are shown in Fig. 5. Indeed, our model yields a $t_c \sim 9.4$ nm, which is comparable to the metal-insulator domain wall width ~ 10 nm found in the phase-field simulations. When the VO₂ layer thickness is below t_c , the total Landau potential of the MM-R configuration will be lower than that of the M1-R configuration, resulting in a stable MM phase in the VO₂ layer.

V. CONCLUSION AND DISCUSSION

We formulated a phase-field model incorporating structural and electronic order parameters as well as free electrons and holes to describe the IMT in doped VO₂ under an electric field. The theory reveals that in the VO_2 slab under an electric field, the electric breakdown inside the supercooling region occurs through an abrupt universal IMT at threshold electric fields much smaller than those expected in the smooth Landau-Zener breakdown, in agreement with the experiment⁹.

A similar phenomenon was also found in a two-orbital Hubbard model of a slab with ~ 20 unit cells, investigated within the dynamical mean-field theory²². Unlike in the microscale slab that the abrupt IMT occurs without any precursor on the insulating $side^{22}$, in our mesoscale slab (L = 250 nm) the metal-insulator-metal sandwich does form as a precursor before the genuine resistive transition. This difference essentially results from the different ratio of the domain wall energy over the total energy in the two scales. In the microscale slab, the domain wall energy dominates the total energy once the domain wall forms, and thus the metal-insulator-metal sandwich at its onset will have a higher total energy than the homogeneous metal. Consequently the electric field will directly change the ground state of the slab from the homogeneous insulator to the homogeneous metal without any precursor²². However, in the mesoscale slab, the domain wall energy is not able to boost the total energy of the sandwich to exceed that of the homogeneous metal, until the insulating region shrinks by the electric field to a threshold length $L_{\rm h}$ [see Fig. 2, in which $L_{\rm h} = (250 - 126) \text{ nm} = 124 \text{ nm at } T = 337 \text{ K}$]. Hence, when the slab length L is longer than $L_{\rm h}$, the ground state of the slab does not directly change from the homogeneous insulator to the homogeneous metal by the electric field, but instead breaks from the homogeneous insulator to the inhomogeneous metal-insulator-metal sandwich before the genuine resistive transition.

When $L > L_{\rm h}$, the threshold electric field $E_{\rm th}$ is scaleindependent, which can be seen through solving Eqs. (7-8). This qualifies the electric field as a well-defined quantity to characterize the phase diagram for $L > L_{\rm h}$. We note that for $L < L_{\rm h}$, however, $E_{\rm th}$ is *scale-dependent*. In this case, the total Landau potentials of the insulator and the metal cross for $\int_0^L dx (\Omega_t|_{\rm R} - \Omega_t|_{\rm M1}) = 0$, giving the relation that $E_{\rm th}$ satisfies,

$$\frac{2k_BT_c}{eE_{\rm th}L}\sinh\left(\frac{eE_{\rm th}L}{2k_BT_c}\right) - 1 = \frac{F|_{\rm R} - F|_{\rm M1}}{\sqrt{N_cN_v}(E_g|_{\rm M1} - E_g|_{\rm R})}$$

It can be seen clearly that $E_{\rm th} \propto L^{-1}$, and that the scaleindependent quantity is the threshold voltage $\Delta V_{\rm th}$ = $E_{\rm th}L$. Therefore, the well-defined quantity to characterize the phase diagram for $L < L_{\rm h}$ is the voltage ΔV instead of the electric field. For this reason we also show $\Delta V_{\rm th}$ corresponding to each value of $E_{\rm th}$ in the phase diagram in Fig. 3.

It is clear that these qualitative behaviors found above by thermodynamic analysis are general for any fielddriven first-order IMT.

In this work we simplified the problem by only considering a uniform electric field or assuming the chargeneutrality approximation $^{22-24}$. This allowed us to obtain some analytical results and interpret the essential physics more clearly. In the most precise calculation, the total electric field should be calculated selfconsistently by solving the Poisson equation 25,26 . The applied electric field will be partially screened by the self-field of charged carriers. From the permittivity and carrier density yielded from capacitance measurements²⁷. the Debye screening length in VO_2 is estimated to be $1 \times 10^1 \sim 2 \times 10^2$ nm, which may be comparable to L/2and the threshold $l_{\rm M}/2$. Therefore, the approximation of ignoring the self-field of carriers or charge-neutrality is reasonable. Particularly if the thickness of the VO_2 film is of the order of 10 nm as in some experiments^{9,20}. the screening effect along the thickness direction will be even less important, and the simplification will be valid for these experimental setups. The screening effect will make the calculated threshold electric fields higher than those calculated without it (thus approaching the experimental value), yet it shall not alter the essential physics about the resistive transition.

Employing the phase-field model, we also found that a metastable MM phase might appear in the hole-doped VO₂, which could be stabilized in the VO₂-VO_{2- δ} bilayer via the geometrical confinement and the size effect. The result may explain the presence of the stable MM phase in the VO₂-VO_{2- δ} bilayer found in the experiment⁷. Our work extends the field of the Landau theory and the phase-field method to strongly correlated systems and may offer a powerful computational method for studying the mesoscale mechanisms of IMT.

VI. ACKNOWLEDGMENT

This work was funded by the Penn State MRSEC, Center for Nanoscale Science, under the award NSF DMR-1420620.

^{*} yxs187@psu.edu

[†] lqc3@psu.edu

¹ Jae Hyung Park, Jim M. Coy, T. Serkan Kasirga, Chunming Huang, Zaiyao Fei, Scott Hunter, and David H. Cobden, "Measurement of a solid-state triple point at the metal-insulator transition in vo2," Nature **500**, 431–434 (2013).

 $^{^2}$ S. Biermann, A. Poteryaev, A. I. Lichtenstein, and A. Georges, "Dynamical singlets and correlation-assisted peierls transition in vo₂," Phys. Rev. Lett. **94**, 026404 (2005).

³ Huihuo Zheng and Lucas K. Wagner, "Computation of the correlated metal-insulator transition in vanadium dioxide from first principles," Phys. Rev. Lett. **114**, 176401 (2015).

- ⁴ W. H. Brito, M. C. O. Aguiar, K. Haule, and G. Kotliar, "Metal-insulator transition in vo₂: A DFT + DMFT perspective," Phys. Rev. Lett. **117**, 056402 (2016).
- ⁵ Zhensheng Tao, Tzong-Ru T. Han, Subhendra D. Mahanti, Phillip M. Duxbury, Fei Yuan, Chong-Yu Ruan, Kevin Wang, and Junqiao Wu, "Decoupling of structural and electronic phase transitions in vo₂," Phys. Rev. Lett. **109**, 166406 (2012).
- ⁶ M. K. Liu, M. Wagner, E. Abreu, S. Kittiwatanakul, A. McLeod, Z. Fei, M. Goldflam, S. Dai, M. M. Fogler, J. Lu, S. A. Wolf, R. D. Averitt, and D. N. Basov, "Anisotropic electronic state via spontaneous phase separation in strained vanadium dioxide films," Phys. Rev. Lett. **111**, 096602 (2013).
- ⁷ D. Lee, B. Chung, Y. Shi, G.-Y. Kim, N. Campbell, F. Xue, K. Song, S.-Y. Choi, J. P. Podkaminer, T. H. Kim, P. J. Ryan, J.-W. Kim, T. R. Paudel, J.-H. Kang, D. A. Tenne, E. Y. Tsymbal, M. S. Rzchowski, L. Q. Chen, J. Lee, and C. B. Eom, "Isostructural metal-insulator transition," (2017), submitted to Science.
- ⁸ Daniel Wegkamp, Marc Herzog, Lede Xian, Matteo Gatti, Pierluigi Cudazzo, Christina L. McGahan, Robert E. Marvel, Richard F. Haglund, Angel Rubio, Martin Wolf, and Julia Stähler, "Instantaneous band gap collapse in photoexcited monoclinic vo₂ due to photocarrier doping," Phys. Rev. Lett. **113**, 216401 (2014).
- ⁹ M Nakano, K Shibuya, D Okuyama, T Hatano, S Ono, M Kawasaki, Y Iwasa, and Y Tokura, "Collective bulk carrier delocalization driven by electrostatic surface charge accumulation," Nature 487, 459–462 (2012).
- ¹⁰ LD Landau, "Zur theorie der energieübertragung (on the theory of the energy transfer)," Phys. Z. Sowjetunion 2 (1932).
- ¹¹ Clarence Zener, "A theory of the electrical breakdown of solid dielectrics," Proceedings of the Royal Society of London. Series A, Containing Papers of a Mathematical and Physical Character **145**, 523–529 (1934).
- ¹² Yanfei Wu, Lele Fan, Qinghua Liu, Shi Chen, Weifeng Huang, Feihu Chen, Guangming Liao, Chongwen Zou, and Ziyu Wu, "Decoupling the lattice distortion and charge doping effects on the phase transition behavior of vo2 by titanium (ti4+) doping," Scientific reports 5, 9328 (2015).
- ¹³ Yin Shi, Fei Xue, and Long-Qing Chen, "Ginzburg-landau theory of metal-insulator transition in vo 2 : The electronic degrees of freedom," EPL (Europhysics Letters) 120, 46003 (2017).
- ¹⁴ Lev Davidovich Landau and Evgenii M Lifshitz, *Statistical physics: V. 5: course of theoretical physics* (Pergamon press, 1968).

- ¹⁵ William Shockley, *Electrons and holes in semiconductors* (van Nostrand, 1953).
- ¹⁶ M. Rini, Z. Hao, R. W. Schoenlein, C. Giannetti, F. Parmigiani, S. Fourmaux, J. C. Kieffer, A. Fujimori, M. Onoda, S. Wall, and A. Cavalleri, "Optical switching in vo2 films by below-gap excitation," Applied Physics Letters 92, 181904 (2008).
- ¹⁷ P Debye and E Hückel, "De la theorie des electrolytes. i. abaissement du point de congelation et phenomenes associes," Physikalische Zeitschrift **24**, 185–206 (1923).
- ¹⁸ Long-Qing Chen, "Phase-field models for microstructure evolution," Annual review of materials research **32**, 113– 140 (2002).
- ¹⁹ Steven R. White and D. J. Scalapino, "Energetics of domain walls in the 2d t - J model," Phys. Rev. Lett. 81, 3227-3230 (1998).
- ²⁰ B. Wu, A. Zimmers, H. Aubin, R. Ghosh, Y. Liu, and R. Lopez, "Electric-field-driven phase transition in vanadium dioxide," Phys. Rev. B 84, 241410 (2011).
- ²¹ Junqiao Wu, Qian Gu, Beth S. Guiton, Nathalie P. de Leon, Lian Ouyang, and Hongkun Park, "Straininduced self organization of metalinsulator domains in single-crystalline vo2 nanobeams," Nano Letters 6, 2313– 2317 (2006), pMID: 17034103.
- ²² G. Mazza, A. Amaricci, M. Capone, and M. Fabrizio, "Field-driven mott gap collapse and resistive switch in correlated insulators," Phys. Rev. Lett. **117**, 176401 (2016).
- ²³ Young-Woo Son, Marvin L Cohen, and Steven G Louie, "Half-metallic graphene nanoribbons," Nature 444, 347 (2006).
- ²⁴ Zhuhua Zhang and Wanlin Guo, "Energy-gap modulation of bn ribbons by transverse electric fields: First-principles calculations," Phys. Rev. B **77**, 075403 (2008).
- ²⁵ Anna N. Morozovska, Eugene A. Eliseev, Olexandr V. Varenyk, Yunseok Kim, Evgheni Strelcov, Alexander Tselev, Nicholas V. Morozovsky, and Sergei V. Kalinin, "Non-linear space charge dynamics in mixed ionic-electronic conductors: Resistive switching and ferroelectric-like hysteresis of electromechanical response," Journal of Applied Physics **116**, 066808 (2014).
- ²⁷ Zheng Yang, Changhyun Ko, Viswanath Balakrishnan, Gokul Gopalakrishnan, and Shriram Ramanathan, "Dielectric and carrier transport properties of vanadium dioxide thin films across the phase transition utilizing gated capacitor devices," Phys. Rev. B 82, 205101 (2010).